

Vishay Siliconix

N-Channel 20 V (D-S) MOSFET



Marking code: AZ

PRODUCT SUMMARY	
V _{DS} (V)	20
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.024
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 2.5 \text{ V}$	0.028
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 1.8 \text{ V}$	0.030
Q _g typ. (nC)	11
I _D (A) a, e	8
Configuration	Single

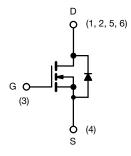
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



APPLICATIONS

- DC/DC converters
- Load switch for portable applications



N-Channel MOSFET

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3464DV-T1-GE3

PARAMETER Drain-source voltage		SYMBOL	LIMIT	UNIT
		V_{DS}	20	
Gate-source voltage		V_{GS}	± 8	V
	T _C = 25 °C		8 a	
Continuous dusin suurent /T 150 °C)	T _C = 70 °C	1 . [8 a	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	7.5 ^{b, c}	
	T _A = 70 °C		6 b, c	А
Pulsed drain current		I _{DM}	20	
Continuous durin diada aument	T _C = 25 °C		3	
Continuous source-drain diode current	T _A = 25 °C	l _S	1.7 ^{b, c}	
	T _C = 25 °C		3.6	
Maximum power dissipation	T _C = 70 °C	1 _ [2.3	147
	T _A = 25 °C	P _D	2 b, c	W
	T _A = 70 °C	†	1.3 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature)			260	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R _{thJA}	50	62.5	°C/W	
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	28	35	C/VV	

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 110 °C/W
- e. Based on T_C = 25 °C



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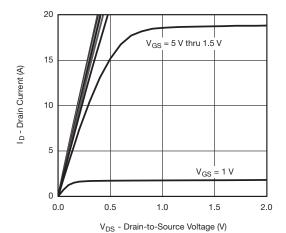
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			1			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	23	-	1400
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-2.6	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.45	-	1	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA
Zava nata valtana duain avuvant		V _{DS} = 20 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10	
On-state drain current a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20	-	-	Α
		$V_{GS} = 4.5 \text{ V}, I_D = 7.5 \text{ A}$	-	0.020	0.024	
Drain-source on-state resistance a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 7 \text{ A}$	-	0.023	0.028	Ω
		$V_{GS} = 1.8 \text{ V}, I_D = 6.7 \text{ A}$	-	0.025	0.030	
Forward transconductance a	9 _{fs}	V _{DS} = 10 V, I _D = 7.5 A	-	17	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	1065	-	
Output capacitance	Coss	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	150	-	pF
Reverse transfer capacitance	C _{rss}		-	70	-	
Tatal sate aboves	Qg	V _{DS} = 10 V, V _{GS} = 5 V, I _D = 7.5 A	-	12	18	nC
Total gate charge			-	11	17	
Gate-source charge	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 7.5 \text{ A}$	-	1.8	-	
Gate-drain charge	Q _{gd}		-	1.1	-	
Gate resistance	Rg	f = 1 MHz	0.4	2.2	4.4	Ω
Turn-on delay time	t _{d(on)}		-	5	10	
Rise time	t _r	$V_{DD} = 10 \text{ V}, R_L = 1.7 \Omega$	-	15	23	-
Turn-off delay time	t _{d(off)}	$I_D\cong 6$ A, $V_{GEN}=4.5$ V, $R_g=1~\Omega$	-	43	65	
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}		-	3	6	ns
Rise time	t _r	V_{DD} = 10 V, R_L = 1.7 Ω	-	12	18	
Turn-off delay time	t _{d(off)}	$I_D\cong 6~A,~V_{GEN}=5~V,~R_g=1~\Omega$	-	22	33	
Fall time	t _f		-	8	16	
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	3	٨
Pulse diode forward current	I _{SM}		-	-	20	A
Body diode voltage	V _{SD}	I _S = 6 A, V _{GS} = 0 V	-	0.75	1.2	V
Body diode reverse recovery time	t _{rr}		-	15	23	ns
Body diode reverse recovery charge	Q _{rr}	$I_F = 6 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	6	12	nC
Reverse recovery fall time	ta	T _J = 25 °C	-	8	-	
Reverse recovery rise time	t _b		-	7	-	ns

Notes

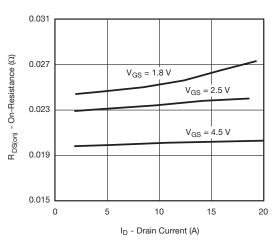
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2%
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

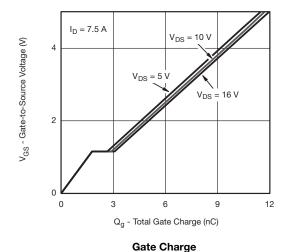


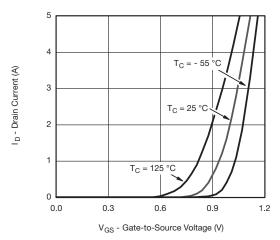


Output Characteristics

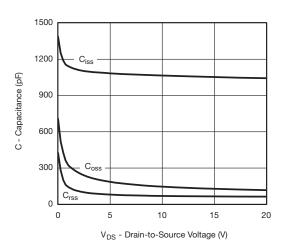


On-Resistance vs. Drain Current and Gate Voltage

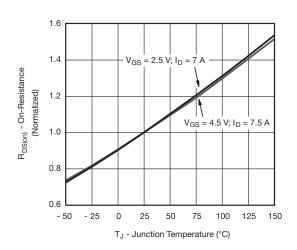




Transfer Characteristics

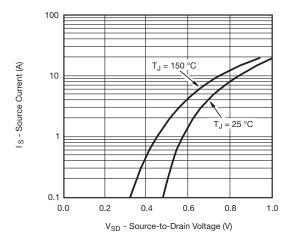


Capacitance

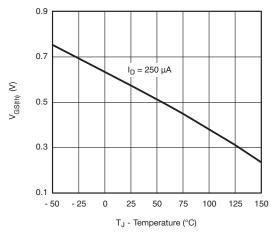


On-Resistance vs. Junction Temperature

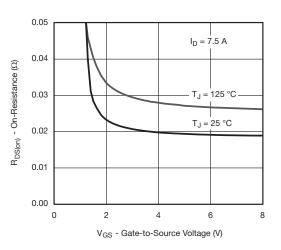




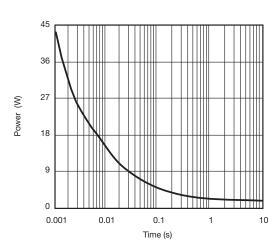
Source-Drain Diode Forward Voltage



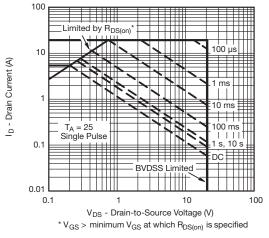
Threshold Voltage



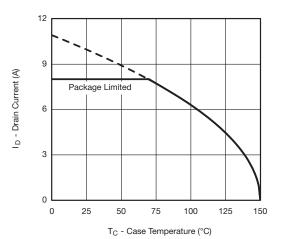
On-Resistance vs. Gate-to-Source Voltage



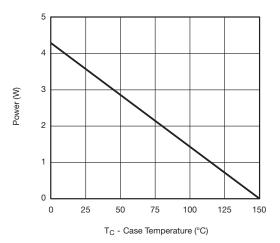
Single Pulse Power (Junction-to-Ambient



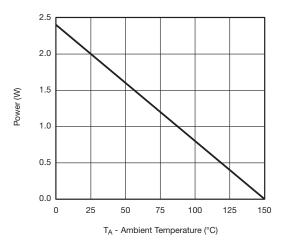




Current Derating a





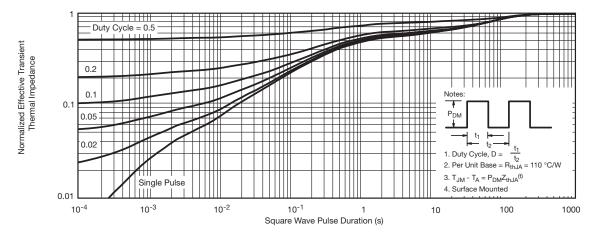


Power Derating, Junction-to-Ambient

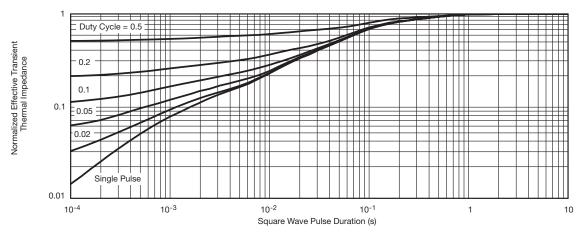
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

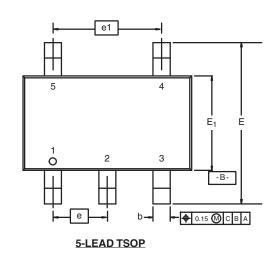
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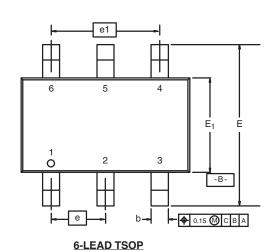


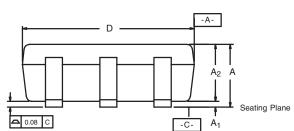


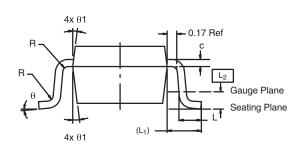
TSOP: 5/6-LEAD

JEDEC Part Number: MO-193C









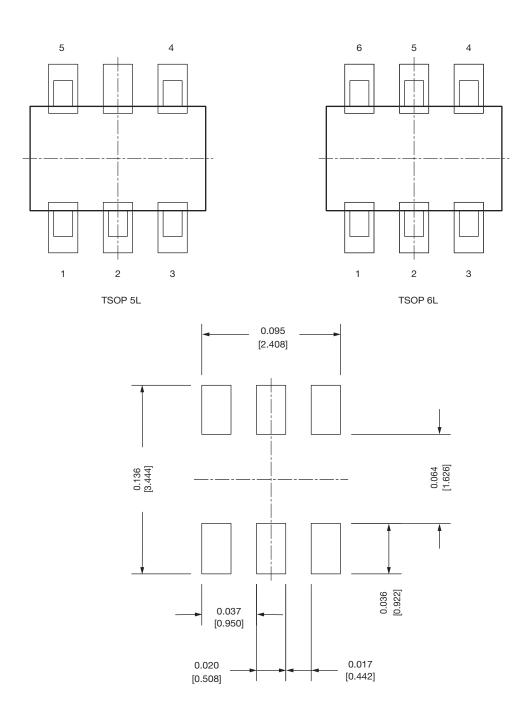
	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁	0.60 Ref			0.024 Ref			
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ_1	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

Document Number: 71200

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Recommended Land Pattern For TSOP-5L / TSOP-6L



Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



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